MGV2520121R5M-10

PHYSICAL DIMENSIONS:

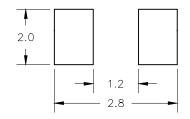
A 2.50 ± 0.20

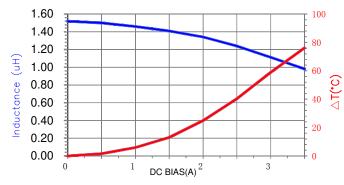
B 2.00 ± 0.20

C 1.20 Max.

 $D = 0.60 \pm 0.30$

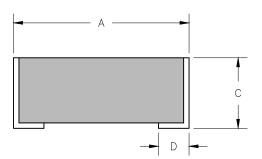
LAND PATTERNS FOR REFLOW SOLDERING



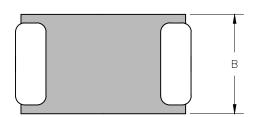


ELECTRICAL SPECIFICATION @ 25°C

	Min	Norm	Max
INDUCTANCE (uH) L @ 1MHz/1mA ±20%	1.20	1.50	1.80
DCR (Ω)		0.064	0.077
Saturation Current Isat (A)		3.20	2.91
Heating Current Irms (A)		2.50	2.27







NOTES:

- 1. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. OPERATING TEMPERATURE RANGE: $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$.
- 4. STORAGE TEMPERATURE RANGE: -50°C ~ +125°C .
- 5. ISat MEANS THAT MAX DC CURRENT WILL CAUSE A PROXIMATELY 30% INDUCTANCE REDUCTION FROM INITIAL VALUE.
- 6. Irms MEANS THAT MAX DC CURRENT WILL CAUSE PROXIMATELY 40°C TEMPERATURE RISE FROM 25±5°C AMBIENT.

	DIMENSIONS ARE IN mm.			This print is the property of Laird					
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				with the understanding that no					
				written consent of Laird Tech. All rights to design or invention are					
				reserved.					
				PROJECT/PART NUMBER:	REV	PART TY	PE:	DRAWN BY:	
				MGV2520121R5M-10	Α	CHO	OKE CTOR	QIU	
				DATE: 06/08/17 SC	ALE: N	TS	SHEET:		
Α	ORIGINAL DRAFT	06/08/17	QIU		IN	13			
RE	V DESCRIPTION	DATE	INT		··· #	-	1	of 1	